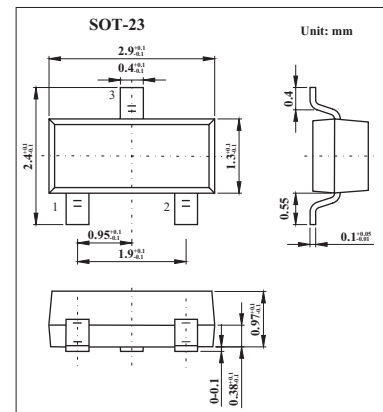


Low-leakage double diode

BAW156

■ Features

- Plastic SMD package
- Low leakage current: typ. 3 pA
- Switching time: typ. 0.8 μ s
- Continuous reverse voltage: max. 75 V
- Repetitive peak reverse voltage: max. 85 V
- Repetitive peak forward current: max. 500 mA.

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Max	Unit
Repetitive peak reverse voltage	V_{RRM}			85	V
Continuous reverse voltage	V_R			75	V
Continuous forward current	I_F	single diode loaded; note 1		160	mA
		double diode loaded; note 1		140	
Repetitive peak forward current	I_{FRM}			500	mA
Non-repetitive peak forward current	I_{FSM}	square wave; $T_j = 25^\circ\text{C}$ prior to surge			A
		$t = 1 \mu\text{s}$		4	
		$t = 1 \text{ms}$		1	
		$t = 1 \text{s}$		0.5	
Total power dissipation	P_{tot}	$T_{amb} \leq 25^\circ\text{C}$; note 1		250	mW
Storage temperature	T_{stg}		-65	+150	$^\circ\text{C}$
Junction temperature	T_j			150	$^\circ\text{C}$
thermal resistance from junction to tie-point	$R_{th-j-t p}$			360	K/W
thermal resistance from junction to ambient	R_{th-j-a}			500	K/W

Note

1. Device mounted on an FR4 printed-circuit board.

BAW156■ Electrical Characteristics $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Typ	Max	Unit
Forward voltage	V_F	$I_F = 1\text{ mA}$		900	mV
		$I_F = 10\text{ mA}$		1000	
		$I_F = 50\text{ mA}$		1100	
		$I_F = 150\text{ mA}$		1250	
Reverse current	I_R	$V_R = 75\text{ V}$	0.003	5	nA
		$V_R = 75\text{ V}; T_j = 150^\circ\text{C}$	3	80	
Diode capacitance	C_d	$f = 1\text{ MHz}; V_R = 0$	3		pF
Reverse recovery time	t_{rr}	when switched from $I_F = 10\text{ mA}$ to $I_R = 10\text{ mA}$; $R_L = 100\ \Omega$; measured at $I_R = 1\text{ mA}$;	0.8	3	$\mu\text{ s}$

■ Marking

Marking	JZp
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